Amendments to the Claims:

This listing of claims will replace all prior versions and listings of claims in the application:

Listing of Claims:

1. A device [[(100, 200, 300)]] for depositing a layer [[(20)]] based on polycrystalline silicon onto a substantially plane, elongate, moving support [[(4)]] having two longitudinal faces [[(43, 44)]] and two longitudinal side edges [[(41, 42)]], the device comprising:

· a crucible [[(1)]] containing a bath [[(2)]] of molten silicon, said support [[(4)]] being designed to be dipped at least in part in the bath and to pass substantially vertically in its long direction through the equilibrium surface [[(21)]] of the bath; and

at least one edge control element [[(5, 5', 15, 15')]], each edge control element being maintained substantially vertically close to one of the two longitudinal side edges [[(41, 42)]];

each edge control element comprising walls [[(51 to 53', 151 to 153')]] defining a longitudinal slot [[(54, 54', 154, 154')]] beside the corresponding longitudinal side edge, each slot being dipped in part in the bath [[(2)]] so as to raise the level of the bath by capillarity in the vicinity of the corresponding longitudinal side edge,

the device being characterized in that wherein at least one of the walls [[(51 to 52', 151 to 152')]], referred to as an "insertion" wall, facing part of one of the longitudinal faces, is substantially plane.

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- 2. A device [[(100, 200, 300)]] according to claim 1, for depositing a layer based on polycrystalline silicon and comprising two edge control elements, in which each edge control element includes two substantially plane insertion walls.
- 3. A device [[(100, 200, 300)]] according to claim 2, for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein the insertion walls are either parallel [[(51 to 52', 151 to 152')]] or else outwardly flared.
- 4. A device [[(100, 200, 300)]] according to claim 2 [[or claim 3]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein the mean depth of each slot [[(54, 154')]] is less than 1 cm.
- 5. A device [[(100, 200, 300)]] according to [[any one of]] clam[[s]] 2 [[to 4]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein the mean spacing between the insertion walls [[(51 to 52', 151 to 152')]] is less than 7 mm.
- 6. A device [[(100, 200)]] according to [[any one of]] claim[[s]] 2 [[to 5]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein the crucible [[(1) comprises]] has a bottom [[(11)]] and side walls [[(12)]], and each of the edge control elements [[(5, 5')]] being stationary and held vertically by the bottom.
 - 7. A device [[(100, 200)]] according to [[any one of]] claim[[s]] 2 [[to 5]], for depositing

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a layer based on polycrystalline silicon, the device being characterized in that wherein the crucible [[comprises]] has a bottom [[(11)]] and side walls [[(12)]], and each of the edge control elements [[(5, 5')]] extend longitudinally to the bottom and preferably forms a monolithic structure with the bottom.

- 8. A device [[(100, 200)]] according to claim 7, for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein each of the edge control elements [[(5, 5')]] presents at least one orifice [[(7, 7')]] dipped in the bath [[(2)]] and suitable for feeding silicon to said element, the orifice being preferably of millimeter order and situated close to the bottom.
- 9. A device (300) according to any one of claims 2 to 6, for depositing a layer based on polycrystalline silicon, the device being characterized in that each of the edge control elements (15, 15') comprises a plate including said slot (154, 154'), the plate being brought into contact with the equilibrium surface (21) of the bath.
- 10. A device [[(300)]] according to claim 9, for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein contact with the surface [[(21)]] of the bath takes place by means of a connection [[(17, 17')]] between the plate and displacement means [[(19, 19')]] external to the crucible [[(1)]], and preferably allowing vertical displacement only.

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- 11. A device [[(300)]] according to claim 9 [[or claim 10]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein each plate [[(15, 15') comprises]] has a disk including said slot [[(154, 154')]] and presenting an effective diameter greater than 10 mm, and preferably equal to about 12 mm.
- 12. A device [[(300)]] according to [[any one of]] claim[[s]] 9 [[to 11]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein the mean spacing between the insertion walls [[(151 to 152')]] is about 2 mm.
- 13. A device [[(100, 200, 300)]] according [[any one of]] claim[[s]] 1 [[to 12]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein each of the edge control elements [[(5, 5', 15, 15')]] is made of a material that does not react with silicon and that is preferably selected from graphite, silicon carbide, and silicon nitride.
- 14. A device [[(100, 200, 300)]] according [[any one of]] claim[[s]] 1 [[to 13]], for depositing a layer based on polycrystalline silicon, the device being characterized in that wherein each of the edge control elements [[(5, 5', 15, 15')]] is made of a material presenting emissivity greater than the emissivity of silicon.